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Docket No. 8733.940.00-US

Filing Date Application No. Examiner Art Unit 10/712,936 - Conf. #9893 November 14, 2003 George R. Koch 1734

Applicant(s): Sang Seok LEE et al.

Invention: SUBSTRATE BONDING APPARATUS FOR LIQUID CRYSTAL DISPLAY DEVICE

#### TO THE COMMISSIONER FOR PATENTS

Transmitted herewith is a Response to Non-Final Office Action in the above-identified application.

| ,                    |   | CLAIM                                   | S AS AMEND                        | DED                 |                         |
|----------------------|---|---|-----------------------------------|---------------------|-------------------------|
|                      | Claims<br>Remaining<br>After<br>Amendment | Highest<br>Number<br>Previously<br>Paid | Number<br>Extra Claims<br>Present | Rate                |                         |
| Total Claims         | 118                                       | - 118 =                                 | \$50                              | ×                   | \$0                     |
| ndependent<br>Claims | 10  | - 10 =                                  | \$200                             | x                   | \$0                     |
| Multiple Depen       | dent Claims (che                          | eck if applicabl                        | le)                               |                     |                         |
| Other fee (pleas     | \$130.00                                  |   |                                   |                     |                         |
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| x Large Entity       | •   |   |                                   | Small En            | tity                    |
| No addition          | al fee is require                         | d for this Resp                         | onse to Non-                      | Final Office Acti   | on.                     |
|                      | ge Deposit Acc                            |   |                                   | the amount of       | \$                      |
| A check in t         | he amount of \$                           | 130.00                                  | to cover                          | the filing fee is e | enclosed.               |
|                      | credit card. Fo                           |   | <del></del>                       | _                   |                         |
|                      | r is hereby auth<br>d below. A dup        |   |                                   | Deposit Accoun      | t No50-0911             |
| x Credit a           | ny overpaymen                             | t.                                      |                                   |                     |                         |
| x Charge             | any additional fili                       | ng or applicatio                        | n processing f                    | ees required und    | er 37 CFR 1.16 and 1.17 |
| Jun 1                | Blle                                      |   |                                   | Dated:              | December 21, 2005       |
| George G/ Ball       | as  |   | •                                 |                     |                         |



## THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Sang Seok LEE et al.

Customer No. 30827

Application No. 10/712,936

Confirmation No. 9893

Filed: November 14, 2003

Art Unit: 1734

For: SUBSTRATE BONDING APPARATUS FOR

LIQUID CRYSTAL DISPLAY DEVICE

Examiner: George R. Koch

# Mail Stop Amendment

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

## AMENDMENT AND RESPONSE TO NON-FINAL OFFICE ACTION

Sir:

In response to the Office Action dated September 23, 2005, please amend the patent application identified above as follows:

## **INTRODUCTORY COMMENTS**

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 23 of this paper.